Last update: 2013.12.1 No.RMC-K-HTS-0006-8 (Uncontrolled copy)

Specification

(Reference)

Title: FIXED THICK FILM CHIP RESISTORS;

RECTANGULAR TYPE

Style: RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

RoHS COMPLIANCE ITEM

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Issue Dept.: Research & Development Department Hokkaido Research Center

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1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type, style of RMC1/32, 1/20, 1/16S, 1/16, 1/10, 1/8, 1/4, 1/2, 1.

1.2 Applicable documents

JIS C 5201-1: 1998, JIS C 5201-8: 1998, JIS C 5201-8-1: 1998

IEC60115-1: 1999, IEC60115-8: 1989 Amendment 1: 1992, IEC60115-8-1: 1989

EIAJ RC-2134B-2002

2. Classification

Type designation shall be the following form.

(Example)

1)	RMC	1/8	_	123	J	TP
	1	2	3	4	5	6
	Styl	е				
2)	RMC	1/8		JP		TP
	1	2		4		6
	Styl	е				

- 1 Fixed thick film chip resistors; rectangular type
- 2 Rated dissipation and / or dimension
- 3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C
-(Dash)	Standard

- 4 Rated resistance Example; $123 \rightarrow 12k\Omega$, Chip jumper: JP
- 5 Tolerance on rated resistance
- 6 Packaging form

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1(1)

Style	Rated dissipation (W)	Temperature coefficient of resistance (10-6 / °C)		Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance			
	, ,		±200 100~1M 534.6		F04.00				
			±300	10~91	E24, 96	F(±1%)			
DMC4/22	0.00	Otomodored	+600~-200	4.7~9.1	E24	,			
RMC1/32	0.03	Standard	±200	100~1M					
			±300	10~91	E24	J(±5%)			
			+600~-200	4.7~9.1		, ,			
			±200	10~1M		D(±0.5%)			
	0.05	0.05 Standard	±200	10~10M	E24, 96	F(±1%)			
			+350~-100	4.02~9.76	∠24, 90				
			+600~-200	1~3.92					
RMC1/20			±200	10~1M		G(±2%)			
			±200	10~10M					
			+350~-100	4.3~9.1	E24	J(±5%)			
			+600~-200	1~3.9					
			+1000~+300	0.47~0.91					
					K	±100	10~1M		D(10 F0()
		Standard	±200	1.02M~3.3M		D(±0.5%)			
		K	±100	10~1M	E24, 96				
RMC1/16S	0.1		±200	1.02M~10M		F(±1%)			
	0.1		+500~-200	1~9.76					
		Standard	±200	10~10M		G(±2%)			
			±200	10~10M	E24	1/+50/ \			
			+500~-200	1~9.1		J(±5%)			

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Table-1(2)

Style	Rated dissipation (W)	Temperature coefficient of resistance (10°/°C)		Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
	(**)		±100	10~3.3M	101 103101013	D(±0.5%)
		K	±100	10~10M	E24, 96	,
			+500~-200	1~9.76	,	F(±1%)
DMC4/4C	0.4		±200	10~10M		0(100()
RMC1/16	0.1	Otavaslavsl	+500~-200	1.0~9.1		G(±2%)
		Standard	±200	10~22M	E24	1/+50/>
			+500~-200	1.0~9.1		J(±5%)
			+1000~+300	0.47~0.91		K(±10%)
		K	±100	10~2.2M		D(10 F0()
		Standard	±200	2.21M~3.3M		D(±0.5%)
		K	±100	10~2.2M	E24,96	
			±200	2.21M~10M		F(±1%)
RMC1/10	0.125		+500~-200	1.0~9.76		
	51125		±200	10~10M		G(±2%)
		Standard	+500~-200	1.0~9.1		G(±2 /6)
			±200	10~22M	E24	J(±5%)
			+500~-200	1.0~9.1		3(±376)
			+1000~+300	0.27~0.91		K(±10%)
	0.25	K	±100	10~1M		
			±200	1.02M~10M	E24,96	F(±1%)
			+500~-200	1.0~9.76		
RMC1/8		Standard	±200	10~10M		G(±2%)
1410170			+500~-200	1.0~9.1		<u> </u>
			±200	10~24M	E24	J(±5%)
			+500~-200	1.0~9.1		
			+1000~+300	0.22~0.91		K(±10%)
		K	±100	10~1M		
			±200	1.02M~10M	E24,96	F(±1%)
514644			+500~-200	1.0~9.76		
RMC1/4	0.5	Standard	±200	10~1M		G(±2%)
				10~22M	E24	J(±5%)
			+500~-200	1.0~9.1		
		16	+1000~+300	0.2~0.91		K(±10%)
		K	±100	10~1M	E24, 96	F(±1%)
			+500~-200	1.0~9.76		C(±20/)
RMC1/2	0.75	Standard	±200	10~1M 10~22M	1	G(±2%)
		Januaru	+500~-200	1.0~9.1	E24	J(±5%)
			+1000~+300	0.33~0.91	1	K(±10%)
		К	±100	10~1M	_	, ,
			+500~-200	1.0~9.76	E24, 96	F(±1%)
DMC.	4.0			10~1M		G(±2%)
RMC1	1.0	Standard	±200	10~22M	F04	, ,
			+500~-200	1.0~9.1	E24	J(±5%)
			+1000~+300	0.33~0.91	1	K(±10%)

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Table-1(3)

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)		
RMC1/32	15	50	FF .40F		
RMC1/20	25	50	<i>–</i> 55∼+125		
RMC1/16S	50	100			
RMC1/16	50	100			
RMC1/10	150				
RMC1/8			<i>–</i> 55∼+155		
RMC1/4	200	500			
RMC1/2	200				
RMC1					

Note. Rated current of chip jumper: RMC1/32: 0.5(A), RMC1/20, 1/16S: 1(A), RMC1/16, 1/10, 1/8, 1/4, 1/2,1: 2(A)

Note. Resistance value of chip jumper: $50 \text{ m}\Omega$ max.

3.2 Climatic category

3.2.1 RMC1/32,1/20

55/125/56 Lower category temperature – 55 °C

Upper category temperature +125 °C

Duration of the damp heat, steady state test 56days

3.2.2 RMC1/16S,1/16,1/10,1/8,1/4,1/2,1

55/155/56 Lower category temperature – 55 °C

Upper category temperature +155 °C

Duration of the damp heat, steady state test 56days

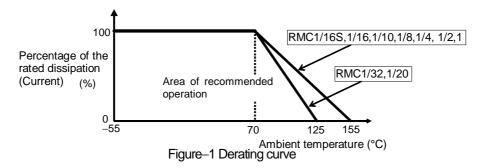
3.3 Stability class

5% Limits for change of resistance:

-for long-term tests \pm (5%+0.1Ω) Chip jumper: 50 mΩ max. -for short-term tests \pm (1%+0.05Ω) Chip jumper: 50 mΩ max.

3.4 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.





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3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{\begin{array}{c} E : Rated \ voltage \ (V) \\ P : Rated \ dissipation \ (W) \\ R : Rated \ resistance \ (\Omega) \end{array}}$$

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Pa	ckaging form	Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	RMC1/32,1/20,1/16S,1/16,1/10 ,1/8,1/4,1/2,1
			5,000 pcs.	RMC1/8
BA	Bulk case	k case		RMC1/10
			25,000 pcs.	RMC1/16
PA	Press pocket taping	8mm width, 2mm pitches	20,000 pcs.	RMC1/32
FA	(paper taping)	ornin widin, zmin pitches	15,000 pcs.	RMC1/20
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RMC1/16S,1/16
TP	Paper taping	Paper taping 8mm width, 4mm pitches		RMC1/16, 1/10, 1/8
TE	Embassed taning	8mm width, 4mm pitches	4,000 pcs.	RMC1/4
ΙE	Embossed taping 12mm width, 4mm pitches		4,000 pcs.	RMC1/2, 1

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

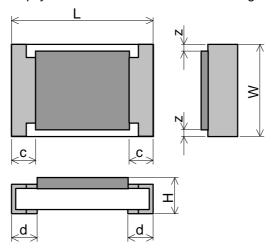


Figure-2

-Bulk, Taping Table-3 Unit: mm

- s, . s.pg		10.0.0					•	
Style	Country of origin	L	W	Н	С	d	Z	
RMC1/32	Japan, Malaysia	0.4±0.02	0.2±0.02	0.13±0.02	0.08±0.03	0.1±0.03		
RMC1/20	Japan, Malaysia	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05		
RMC1/16S	Malaysia, China	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	$0.25^{+0.05}_{-0.10}$		
RMC1/16	Malaysia, China	1.6±0.1	0.8_0.05	0.45±0.10	0.3±0.1	0.3±0.1		
RMC1/10	Malaysia, China	2.0±0.1	1.25±0.10	0.55±0.10	0.4±0.2	0.4±0.2		
RMC1/8	Malaysia,	3.2±0.15	1.6±0.15	0.55±0.10	0.5±0.25	0.5±0.25	0.05~0.3	
KIVIC 1/0	China	3.1±0.1	1.6±0.1	0.6±0.15	0.45±0.20	0.5±0.2	0~0.1	
RMC1/4	Malaysia	3.2±0.15	2.5±0.15	0.55±0.15	0.5±0.25	0.5±0.25	0.05~0.3	
RMC1/2	Malaysia	5.0±0.15	2.5±0.15	0.55±0.15	0.6±0.2	0.6±0.2	0.05~0.35	
RMC1	Malaysia	6.3±0.15	3.2±0.15	0.55±0.15	0.6±0.2	0.6±0.2	0.05~0.35	

-Bulk case Unit : mm

Style	Country of origin	L	W	Н	С	d	Z
RMC1/16	Malaysia	1.6 +0.10 -0.05	0.8 +0.1	0.4 +0.08	0.25 ± 0.10	0.3 ± 0.1	
RMC1/10	Malaysia	2.0 ± 0.1	1.25 ± 0.10	0.5 +0.1	0.4 ± 0.2	0.4 ± 0.2	
RMC1/8	Malaysia	3.1 ± 0.1	1.55 ^{+0.10} _{-0.05}	0.5 +0.1	0.5 ± 0.25	0.5 ± 0.25	0.05 ~ 0.03

5.2 Net weight (Reference)

<u> </u>	,
Style	Net weight(mg)
RMC1/32	0.035
RMC1/20	0.16
RMC1/16S	0.6
RMC1/16	2
RMC1/10	5
RMC1/8	9
RMC1/4	16
RMC1/2	25
RMC1	40

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6. Marking

The Rated resistance of RMC1/32, 1/20, 1/16S should not be marked.

6.1 RMC1/10,1/8,1/4,1/2,1

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• Malaysia products: E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

• China products(RMC1/10,1/8): J(±5%): 3 digits, F(±1%): 4 digits

Marking example		Contents	Application
Malaysia	China	Contents	Application
123	123	$12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	RMC1/10,1/8,1/4,1/2,1
2R2	2R2	2.2 [Ω]	Less than 10Ω of RMC1/8,1/4,1/2,1
2.2	2R2	2.2 [Ω]	Less than 10Ω of RMC1/10
5623	5623	$562\times10^3 [\Omega] \rightarrow 562[k\Omega]$	RMC1/10,1/8,1/4,1/2,1
12R7	12R7	12.7 [Ω]	RMC1/10,1/81/4,1/2,1

6.2 RMC1/16

The nominal resistance shall be marked in 3 digits (E24 and/or E96) and marked on over coat side. No marking in the E96 series of a Malaysia.

In case of the resistance value that E96 overlaps with E24, there is a case to mark in E96.

Marking ex	ample	Contents	Application	
Malaysia	China	Contents		
123	123	$12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	E24	
2R2	2R2	2.2 [Ω]	E24	
No marking	02C	$102\times10^2 \left[\Omega\right] \rightarrow 10.2 \left[k\Omega\right]$	E96	
No marking	51X	332×10^{-1} [Ω] $\rightarrow 33.2$ [Ω]	E96	

6.2.1 Symbol for E96 series of resistance value

Symbolio Lao series di resistarice value									
E96	Symbol	E96	Symbol	E96	Symbol	E96	Symbol	E96	Symbol
100	01	162	21	261	41	422	61	681	81
102	02	165	22	267	42	432	62	698	82
105	03	169	23	274	43	442	63	715	83
107	04	174	24	280	44	453	64	732	84
110	05	178	25	287	45	464	65	750	85
113	06	182	26	294	46	475	66	768	86
115	07	187	27	301	47	487	67	787	87
118	80	191	28	309	48	499	68	806	88
121	09	196	29	316	49	511	69	825	89
124	10	200	30	324	50	523	70	845	90
127	11	205	31	332	51	536	71	866	91
130	12	210	32	340	52	549	72	887	92
133	13	215	33	348	53	562	73	909	93
137	14	221	34	357	54	576	74	931	94
140	15	226	35	365	55	590	75	953	95
143	16	232	36	374	56	604	76	976	96
147	17	237	37	388	57	619	77		
150	18	243	38	392	58	634	78		
154	19	249	39	402	59	649	79		
158	20	255	40	412	60	665	80		

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6.2.2 Symbol of multipliers

Symbol	Υ	Χ	Α	В	С	D	Е	F
Multipliers	10 ⁻²	10 ⁻¹	10 ⁰	10 ¹	10 ²	10 ³	10 ⁴	10 ⁵

6.3 Marking example of Jumper Chip

Marking exa	mple	Contents	Application	
Malaysia	China	Contents	Application	
O or 000	000		RMC1/16	
0	000	JP	RMC1/10,1/8	
000			RMC1/4,1/2,1	

7. Performance

- 7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 1998.
- 7.2 The performance shall be satisfied in Table-4.

Table-4(1)

	T	Iable-4(1)		
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements	
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1	
		Checked by visual examination.	The marking shall be legible, as	
			checked by visual examination.	
2	Dimension	Sub-clause 4.4.2	As specified in Table–3 of this	
	Resistance	Cub alouas 4.5	specification. As in 4.5.2	
	resistance	Sub-clause 4.5	The resistance value shall	
			correspond with the rated resistance	
			taking into account the specified	
			tolerance.	
			Chip jumper: $50 \text{m}\Omega$ max.	
3	Voltage proof	Sub-clause 4.7		
		Method: 4.6.1.4(See Figure–5)	No breakdown or flash over	
		Test voltage: Alternating voltage with a peak		
		value of 1.42 times the		
		insulation voltage. Duration: 60 s ± 5 s		
		Insulation resistance	R≥1GΩ	
		Test voltage: Insulation voltage	N=1032	
		Duration: 1 min.		
4	Solderability	Sub-clause 4.17	As in 4.17.4.5	
		Without ageing	The terminations shall be covered	
		Flux: The resistors shall be immersed in a	with a smooth and bright solder	
		non-activated soldering flux for 2s.	coating.	
		Bath temperature: 235 °C ± 5 °C		
		Immersion time: 2 s ± 0.5 s		



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Table 4(2)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
5	Mounting	Sub-clause 4.31	1 21.0
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Overload	Sub-clause 4.13	
	(in the mounted state)	The applied voltage shall be 2.5 times the	
		rated voltage or twice the limiting element	
		voltage, whichever is the less severe.	
		Duration: 2 s	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Cabinat masisteness of the		Chip jumper: $50 \text{m}\Omega$ max.
	Solvent resistance of the	Sub-clause 4.30	Legible marking
	marking	Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 1	
		Rubbing material: cotton wool	
6	Mounting	Without recovery	
6	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Bound strength of the end face	Test substrate: Figure 4	
	plating	Sub-clause 4.33	
	Plating	Bent value: 3 mm (3225 size max.) 1 mm (5025 siz min.)	
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
		i vesisiai ice	Chip jumper: $50m\Omega$ max.
	Final measurements	Sub-clause 4.33.6	No visible damage
		Visual examination	The second second grant
7	Resistance to soldering heat	Sub-clause 4.18	
-		Solder temperature: 260 °C ± 5 °C	
		Immersion time: 10 s ± 0.5 s	
		Visual examination	As in 4.18.3.4
			No sign of damage such as cracks.
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
			Chip jumper: $50 \text{m}\Omega$ max.
	Component solvent resistance	Sub-clause 4.29	
		Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
			Chip jumper: $50m\Omega$ max.

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Table-4(3)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
8	Mounting	Sub-clause 4.31	7 5555 754455
	Wisariang	Substrate material: Epoxide woven glass	
		Test substrate: Figure—3	
	Adhesion	Sub-clause 4.32	
	71311331311	Force: 5 N	
		(RMC1/32: 2N, RMC1/20: 3N)	
		Duration: 10 s ± 1 s	No visible damage
	Rapid change temperature	Visual examination	The violible damage
	Trapia draingo tomporataro	Sub-clause 4.19	
		RMC1/32,1/20	
		Lower category temperature: -55 °C	
		Upper category temperature: +125 °C	
		RMC1/16S,1/16,1/10,1/8,1/4,1/2,1	
		Lower category temperature: –55 °C	
		Upper category temperature: +155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	No visible damage
		Visual examination	$\Delta R \le \pm (1\% + 0.05\Omega)$
		Resistance	Chip jumper: $50m\Omega$ max.
9	Climatic sequence	Sub-clause 4.23	Offip jumpor. Comiss max.
١	-Dry heat	Sub-clause 4.23.2	
	Dry ricat	RMC1/32,1/20	
		Test temperature: +125 °C	
		RMC1/16S,1/16,1/10,1/8,1/4,1/2,1:	
		Test temperature: +155 °C	
		Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
	1 not oyolo	[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	-Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
	. torrian in ig by old	[Severity (2)]	
		Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7	
	2.5.1544	The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is	
		the smaller.	
		Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
		1 Coloidi 100	Chip jumper: $50 \text{m}\Omega$ max.

Drawing No: RMC-K-HTS-0006

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

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/8

Table-4(4)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
10	Mounting	Sub-clause 4.31	
	J J	Substrate material: Epoxide woven glass	
		(RMC1may use Alumina substrate.)	
		Test substrate: Figure-3	
	Endurance at 70 °C	0.1.1.4054	
	Endurance at 70 C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h	
		on and 0.5 h off.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is	
		the smaller.	
		Examination at 48 h , 500 h and 1000 h:	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
			Chip jumper: $50 \text{m}\Omega$ max.
11	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Variation of resistance with	Test substrate: Figure–3 Sub–clause 4.8	As in Table–1
	temperature	Sub-clause 4.8 RMC1/32,1/20:	AS III Table—I
		_55 °C / +20 °C	
		+20 °C / +125°C	
		RMC1/16S,1/16,1/10,1/8,1/4,1/2,1:	
		–55 °C / +20 °C	
		+20 °C / +155°C	
12	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Damp heat, steady state	Test substrate: Figure–3 Sub–clause 4.24	
	Damp near, creaty crate	Ambient temperature: 40 °C ± 2 °C	
		Relative humidity: 93 $\frac{+2}{-3}$ %	
		a) 1st group: without voltage applied.	
		b) 2nd group: The d. c. voltage shall be	
		applied continuously.	
		The voltage shall be accordance with	
		Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)]	
		Visual examination	No visible damage
			Legible marking
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
			Chip jumper: $50m\Omega$ max.

Drawing No: RMC-K-HTS-0006 /8

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

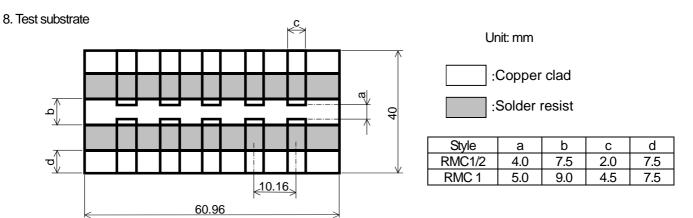
RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 11/18

Table-4(5)

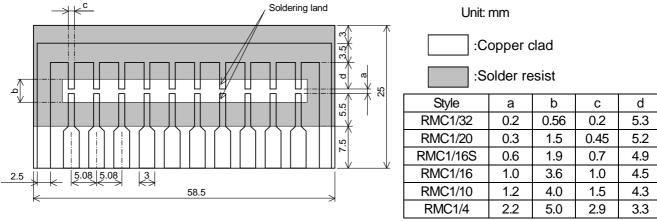
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table-3
	Mounting	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3	
	Endurance at upper category temperature	Sub-clause 4.25.3 RMC1/32,1/20: Ambient temperature:125 °C ±2 °C RMC1/16S,1/16,1/10,1/8,1/4,1/2,1: Ambient temperature:155 °C ±2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$ Chip jumper: $50m\Omega$ max.

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

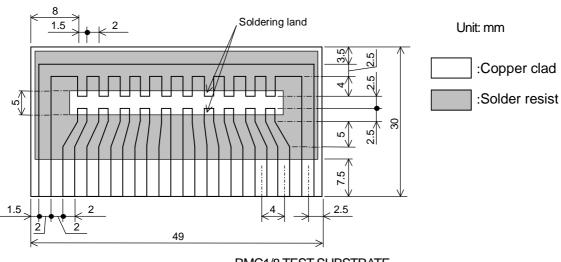
RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 12/18



RMC1/2, 1 TEST SUBSTRATE



RMC1/20, 1/16S, 1/16, 1/10 1/4 TEST SUBSTRATE



RMC1/8 TEST SUBSTRATE Figure-3

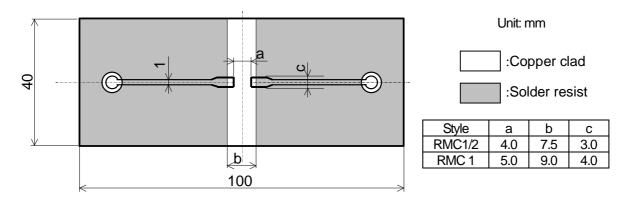
Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

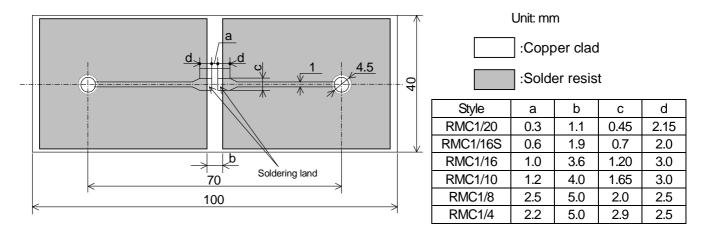
In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

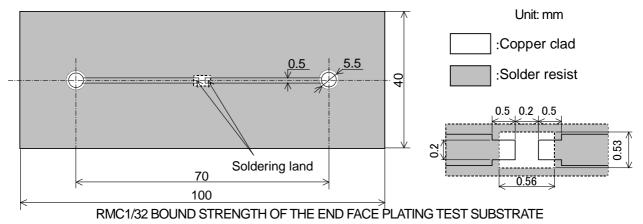
RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 13/18



RMC1/2, 1 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE



RMC1/20,1/16S,1/16,1/10,1/8,1/4 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE



Thickness: 1.6mm Thickness of copper clad: 0.035mm

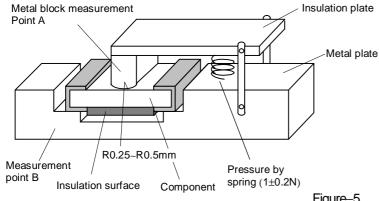
Figure-4

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 14/18

· RMC1/16S,1/16,1/10,1/8,1/4,1/2,1

· RMC1/32, 1/20



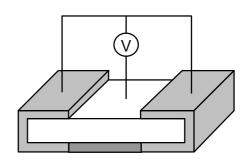
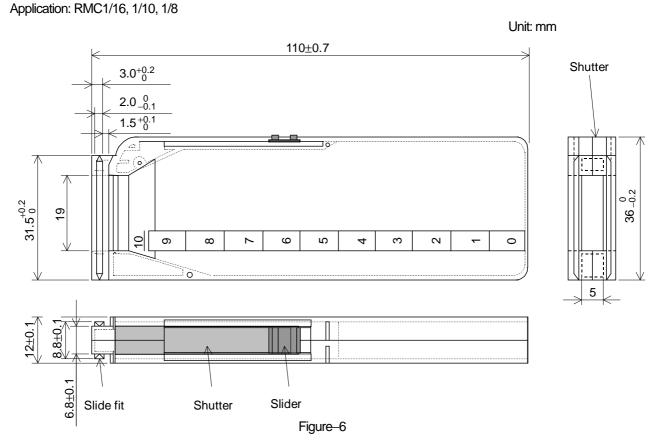


Figure-5

- 9. Design and dimensions of bulk case
- 9.1 Applicable documents JIS C 0806-6:2006
- 9.2 The bulk case shall be of the design and physical dimensions in accordance with Figure-6.



Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 15/18

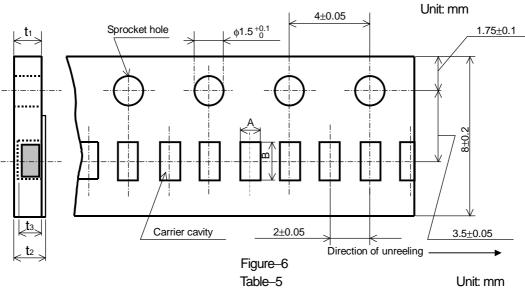
10. Taping

10.1 Applicable documents JIS C 0806-3: 1999, EIAJ ET-7103: 2004, EIAJ ET-7200B: 2003

10.2 Taping dimensions

10.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-5.



lable-5					Unit: mm
Style	Α	В	t ₁	t ₂	t ₃
RMC1/32	0.24±0.03	0.45±0.03	0.31±0.03	0.36±0.02	0.15±0.02
RMC1/20	0.37±0.05	0.67±0.05	0.42±0.03	0.45±0.05	0.27±0.02

10.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-8 and Table-6.

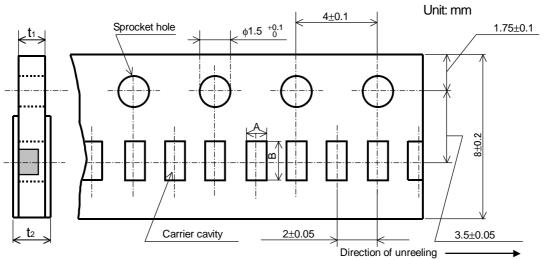


Figure-8

	Unit: mm			
Style	Α	В	t 1	t ₂
RMC1/16S	$0.65^{+0.05}_{-0.10}$	1.15 ^{+0.05} _{-0.10}	0.4 ± 0.05	0.5max.
RMC1/16	1.15±0.15	1.9±0.2	0.6±0.1	0.8max.

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 16/18

10.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-9 and Table-7.

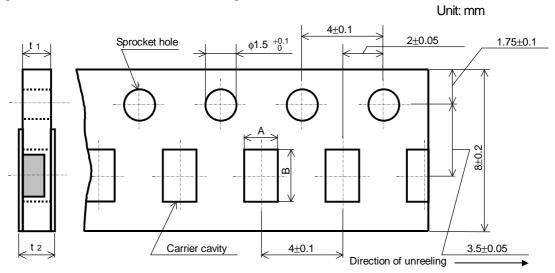
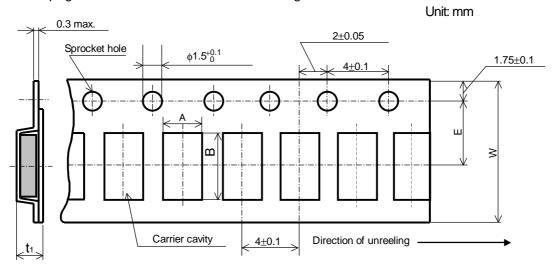


Figure-9 Table-7 Unit: mm Style В t₁ t₂ RMC1/16 1.15±0.15 1.9±0.2 0.6±0.1 0.8max. RMC1/10 1.65±0.15 2.5±0.2 0.8 ± 0.1 1.0max. RMC1/8 2.00±0.15 3.6 ± 0.2

10.2.4 Embossed taping dimensions shall be in accordance with Figure-10 and Table-8.



Figure_10

Table_8

Unit: mm

B

W

E

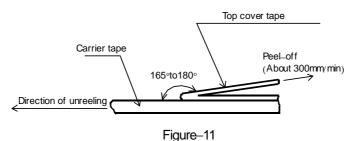
t
1

Style	Α	В	W	Е	t 1
RMC1/4	2.85±0.20	3.5±0.2	8.0±0.3	3.5±0.05	1.0±0.2
RMC1/2	3.1±0.2	5.5±0.2	12.0±0.3	5.5±0.05	1.1±0.15
RMC 1	3.6±0.2	6.9±0.2	12.0±0.3	0.0±0.05	1.1±0.15

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMC1/32,1/20: Figure–11, RMC1/16S, 1/16, 1/10, 1/8: Figure–12, RMC1/4, 1/2, 1: Figure–13.
- 6). When the tape is bent with the minimum radius for RMC1/32, 1/20, 1/16S, 1/16, 1/10,1/8, 1/4: 25 mm, or RMC1/2, 1: 30 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- In no case shall there be two or more consecutive components missing.
 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



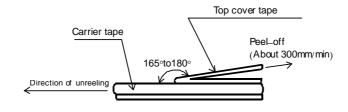
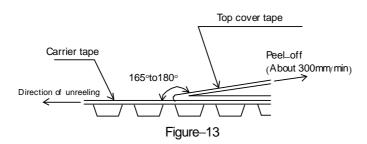


Figure-12

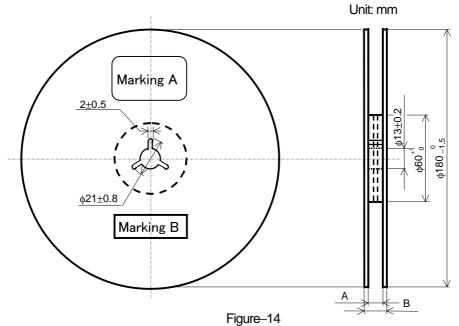


Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 18/18

10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–14 and Table–9. Plastic reel (Based on EIAJ ET–7200B)

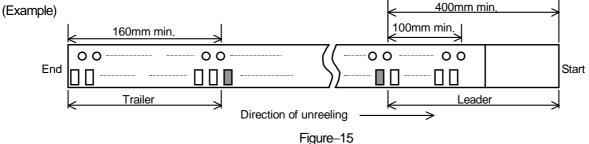


Figure–14
Table–9

Table-	Unit: mm		
Style	Α	В	Note
RMC1/32, 1/20, 1/16S, 1/16, 1/10, 1/8, 1/4	9 +1.0	11.4±1.0	Injection molding
1(WC1/32, 1/20, 1/103, 1/10, 1/10, 1/0, 1/4	9 0	13±1.0	Vacuum forming
RMC1/2, 1	13 ^{+1.0}	17±1.0	Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

10.4 Leader and trailer tape.



11. Marking on package

The label of a minimum package shall be legibly marked with follows.

11.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

11.2 Marking B (KAMAYA Control label)